Tyrone Camarero Specifications

Camarero SDI100C3R-28

Key features

Virtualization, Enterprise Server, Data Center Optimized, Application and data serving, Model analysis, Compute Intensive Applications

- Dual Socket P+ (LGA-4189), 3rd Gen Intel® Xeon® Scalable processors, Support CPU TDP 270W
- Intel® C621A
- Memory Capacity: 18 DIMM slots, UP to 4TB: PMem and DRAM, Memory Type: 3200MHz ECC LRDIMM/RDIMM DDR4
- Intel® Optane™ persistent memory 200 series
- 6 PCI-E expansion slots
- Dual 1GbE LAN ports
- 8x 3.5" SATA drive bays
- 3 heavy duty fans with optimal fan speed control
- 600/650/800/1200W Redundant Power Supply





Processor/Cache

Dual Socket P+ (LGA-4189), 3rd Gen Intel® Processor

Xeon® Scalable processors, Support CPU TDP 270W

Chipset

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Intel® C621A

System Memory

Memory Capacity

18 DIMM slots, UP to 4TB: PMem and DRAM, Type: 3200MHz ECC L RDIMM/RDIMM DDR4 Intel® Optane™ persistent memory 200 series

Expansion Slots

PCI-Express

Slot 1: PCI-E 4.0 x8 LP, Slot 2: PCI-E 4.0 x16 LP, Slot 3: PCI-E 4.0 x16 LP, Slot 4: PCI-E 4.0 x16 LP, Slot 5: PCI-E 4.0 x16 LP, Slot 6: PCI-E 4.0 x8 LP

Integrated Onboard

Network Connectivity IPMI

2x 1GbE port(s)

Support for Intelligent Platform Management v.2.0, IPMI 2.0 with virtual media over LAN and

1decicated IPMI LAN port

2 USB 2.0 port(s) (2 front), 4 USB 3.0 port(s) (4 rear)

Add-on Options

Raid Card

None

Optical Drive

Optionale

Front Panel

LEDs

HDD activity, Network activity, Power status,

System information (overheat/UID)

Buttons

Power On/Off , System Reset

Drive Bays

HDD Bays

8x 3.5" hot-swap fixed optional drive bays,

1 M.2 NVMe

Peripheral Bays 1x slim DVD drive bays (optional)

Power Supply

600/650/800/1200W Redundant Power Supply

Cooling System

3 heavy duty fans with optimal fan speed control

Form Factor

Form Factor

2U Rackmount

Dimensions:

Height: 3.5"" (89mm),

Width, 17.2"" (437mm), Depth: 25.5"" (647mm)

Email: info@tyronesystems.com For more/current product information, visit

www.tyronesystems.com

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